

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
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Schieck et al.) Examiner: Duong, Khanh
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Serial No.: 10/789,637) Art Unit: 2822
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Filed: February 27, 2004))
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For: A Flip Chip Semiconductor Die)
Internal Signal Access System)
)
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)

SUPPLEMENTAL RESPONSE TO OFFICE ACTION

Assistant Commissioner of Patents
and Trademarks
Washington, D.C. 20231

Dear Sir:

In response to the outstanding Office Action mailed October 14, 2009
Applicants respectfully submit the present Supplemental Response to indicate
cancelled claims and correct informalities (e.g., typographical error). Applicants
respectfully request allowance of the remaining Claims. Immediately after this
transmittal page starting on a separate page is a complete listing of the Claims
including Amendments, followed by Applicant Argument (or Remarks).